

## *Sensors and Materials*

### **Special Issue on High-sensitivity Sensors and Sensors for Difficult-to-measure Objects**

#### **Call for Papers**

High-sensitivity sensors are required in the fields of environment sensing for safety and biosensing for pathological diagnosis. In these fields, it is necessary to not only increase sensitivity but also improve the S/N ratio. Additionally, stability and durability are important to monitor low-opportunity and low-frequency events in the long term. Recently, various new materials, structures, MEMSs, and sensor systems have been developed for enhancing sensor devices. This special issue calls for papers that investigate methods for realizing high-sensitivity sensors and sensing for difficult-to-measure objects with advanced technologies and novel ideas.

#### **Scope (including but not limited to):**

- Environment sensors
- Biosensors
- Low-opportunity and low-frequency events
- Improvement of S/N ratio
- High sensitivity, stability, and durability

**Submission due date:** ~~September 30, 2020~~ extended to **November 30, 2020**

**Publication date (planned):** First or second half of 2021

**Journal website:** <https://myukk.org/>

**Guest Editors:** Dr. Ki Ando (Tokyo Denki University)

**Submit to:** Online Manuscript Submission System (<https://myukk-org.ssl-xserver.jp/form/>)

#### **(Attention)**

As stated in Instructions to Authors in the Guidelines, the author(s) will be obliged to pay the publication fee upon the acceptance of the manuscript for publication (for example, JPY 99360 for 10 pages in *Sensors and Materials* format). If the quality of the English of your manuscript does not satisfy the journal standards, the authors will bear the proofreading fee (JPY 10000–15000 for electronic proofreading), which will be charged with the publication fee.

If you have any questions, please feel free to contact the editorial staff at the address below.

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